

Qualification of New Adhesive Material and Molding Compound for Select LFCSP Packages

Detailed Change Description

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BOM	Old	Newly Added
Adhesive	Ablestik 8290 Ablestik 3230	Hitachi EN4900GC
Molding Compound	Sumitomo G770 Hitachi 9220HF13	Sumitomo G700LA